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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





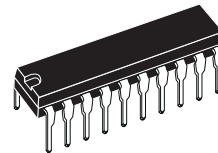
TDA7480

10W MONO CLASS-D AMPLIFIER

- 10W OUTPUT POWER:
 $R_L = 8\Omega/4\Omega$; THD = 10%
- HIGH EFFICIENCY
- NO HEATSINK
- SPLIT SUPPLY
- OVERVOLTAGE PROTECTION
- ST-BY AND MUTE FEATURES
- SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION

DESCRIPTION

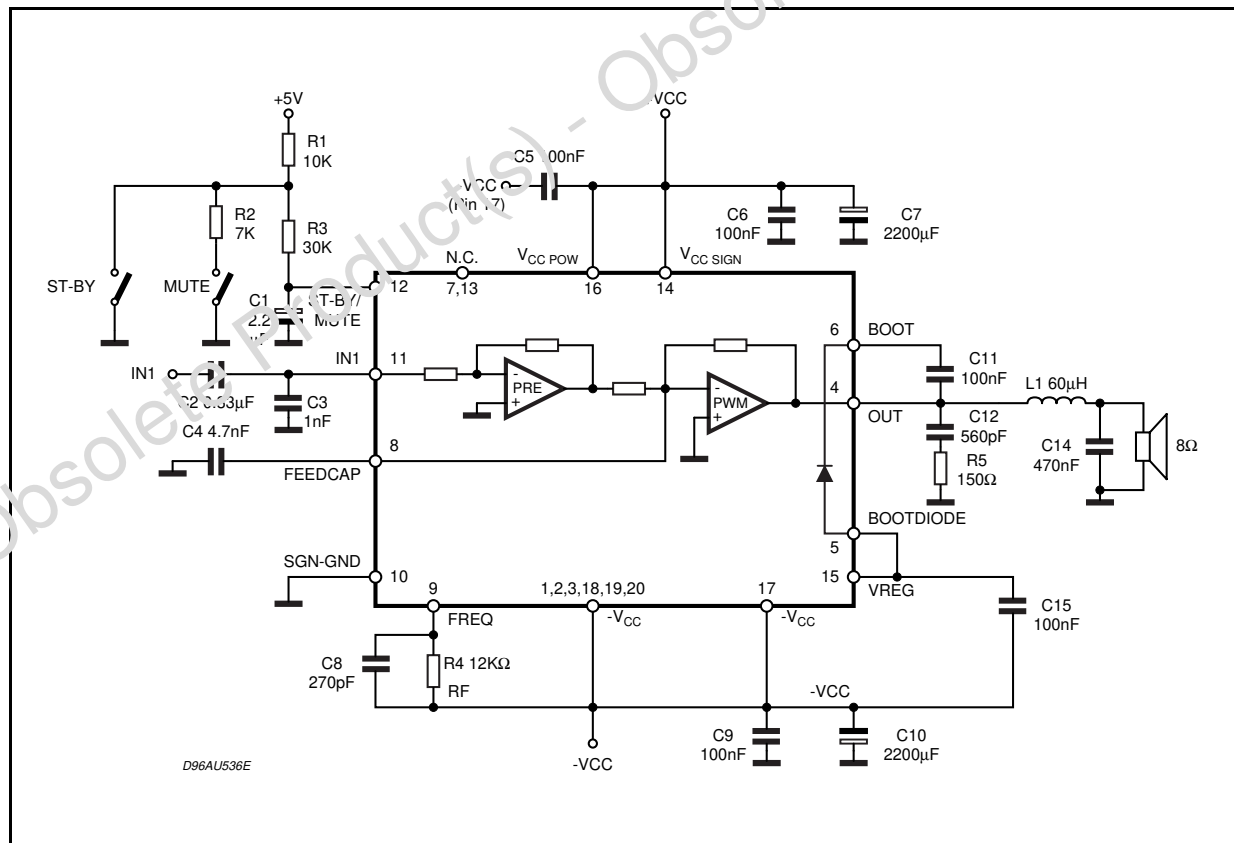
The TDA7480 is an audio class-D amplifier assembled in Power DIP package specially designed for high efficiency applications mainly for TV and Home Stereo sets.



PDIP20 (14+3+3)

ORDERING NUMBER: TDA7480

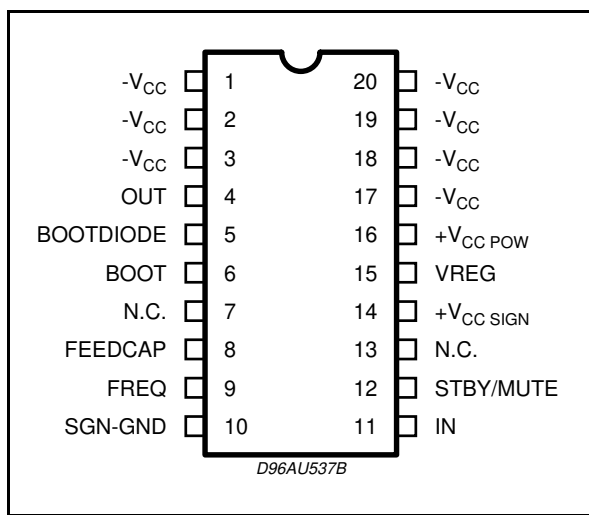
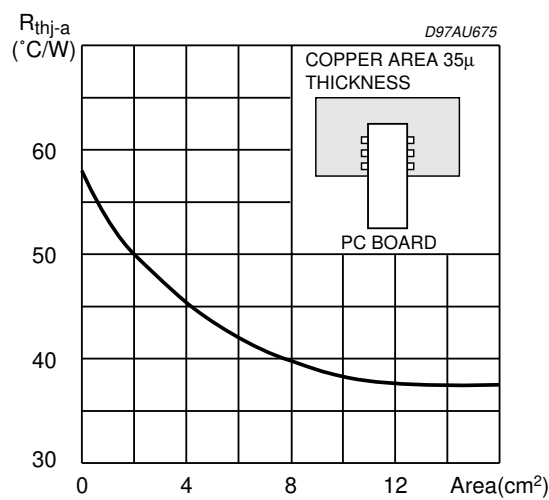
Figure 1: Test and Application Circuit.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	± 20	V
T_{stg}, T_j	Storage and Junction Temperature	-40 to 150	$^{\circ}\text{C}$
V_{FREQ}	Maximum Voltage Across VFREQ (Pin 9)	8	V
T_{op}	Operating Temperature Range	-20 to 70	$^{\circ}\text{C}$
ESD	Maximum ESD on Pins	± 1.8	kV

PIN CONNECTION (Top view)

R_{th} with "on board" Square Heatsink vs. copper area.

THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{thj-amb}$	Thermal Resistance Junction to ambient	80	$^{\circ}\text{C/W}$
$R_{thj-pin}$	Thermal Resistance Junction to Pin	Max. 12	$^{\circ}\text{C/W}$

PIN FUNCTIONS

N.	Name	Function
1	$-V_{CC}$	NEGATIVE SUPPLY.
2	$-V_{CC}$	NEGATIVE SUPPLY.
3	$-V_{CC}$	NEGATIVE SUPPLY.
4	OUT	PWM OUTPUT
5	BOOTDIODE	BOOTSTRAP DIODE ANODE
6	BOOT	BOOTSTRAP CAPACITOR
7	NC	NOT CONNECTED
8	FEEDCAP	FEEDBACK INTEGRATING CAPACITANCE
9	FREQUENCY	SETTING FREQUENCY RESISTOR
10	SGN-GND	SIGNAL GROUND
11	IN	INPUT
12	ST-BY-MUTE	ST-BY/ MUTE CONTROL PIN
13	NC	NOT CONNECTED
14	$+V_{CC}$ SIGN	POSITIVE SIGNAL SUPPLY
15	VREG	10V INTERNAL REGULATOR
16	$+V_{CC}$ POW	POSITIVE POWER SUPPLY
17	$-V_{CC}$	NEGATIVE SUPPLY (TO BE CONNECTED TO PIN 16 VIA C5)
18	$-V_{CC}$	NEGATIVE SUPPLY
19	$-V_{CC}$	NEGATIVE SUPPLY
20	$-V_{CC}$	NEGATIVE SUPPLY

ELECTRICAL CHARACTERISTICS (Refer to the test circuit, $V_{CC} = \pm 14V$; $R_L = 8\Omega$; $R_S = 50\Omega$; $R_f = 12K\Omega$; Demod.. filter $L = 60\mu H$, $C = 470nF$; $f = 1KHz$; $T_{amb} = 25^\circ C$ unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_S	Supply Range		± 10		± 16	V
I_q	Total Quiescent Current	$R_L = \infty$; NO LC Filter		25	40	mA
V_{OS}	Output Offset Voltage	Play Condition	-50		+50	mV
P_O	Output Power	THD = 10% THD = 1%	8.5 6	10 7		W W
		$R_L = 4\Omega$ $V_{CC} = \pm 10.5V$ THD = 10% THD = 1%		10 7		W W
$P_d (*)$	Dissipated Power at 1W Output Power	$R_f = 12K\Omega$ $P_O = 1W$		1		W
P_{DMAX}	Maximum Dissipated Power	$P_O = 10W$ THD 10% $R_{th-j-amb} = 38^\circ C/W$ (Area $12cm^2$)		1.8		W
η	Efficiency $= \frac{P_O}{P_O + P_D} \equiv \frac{P_O}{P_I} (**)$	THD 10% $R_{th-j-amb} = 38^\circ C/W$ (Area $12cm^2$)	80	85		%
THD	Total Harmonic Distortion	$R_L = 8\Omega$; $P_O = 0.5W$		0.1		%
I_{max}	Overcurrent Protection Threshold	$R_L = 0$	3.5	5		A
T_j	Thermal Shut-down Junction Temperature			150		$^\circ C$
G_V	Closed Loop Gain		29	30	31	dB
e_N	Total Input Noise	A Curve $f = 20Hz$ to $22KHz$		7 12		μV μV
R_i	Input Resistance		20	30		$K\Omega$
SVR	Supply Voltage Rejection	$f = 100Hz$; $V_r = 0.5$	46	60		dB
T_r, T_f	Rising and Falling Time			50		ns
$R_{DS(on)}$	Power Transistor on Resistance			0.4		Ω
F_{SW}	Switching Frequency		100	120	140	KHz
F_{SW_OP}	Switching Frequency Operative Range		100		200	KHz
B_F	Zero Signal Frequency Constant (***)			1.4×10^9		Hz Ω
R_F	Frequency Controller Resistor Range (****)		7	12	14	$K\Omega$
MUTE & STAND-BY FUNCTIONS						
V_{ST-BY}	Stand-by range				0.8	V
V_{MUTE}	Mute Range		1.8		2.5	V
V_{PLAY}	Play Range (1)		4			V
A_{MUTE}	Mute Attenuation		60	80		dB
I_{qST-BY}	Quiescent Current @ Stand-by			3	5	mA

*: The output average power when the amplifier is playing music can be considered roughly 1/10 of the maximum output power. So it is useful to consider the dissipated power in this condition for thermal dimensioning.

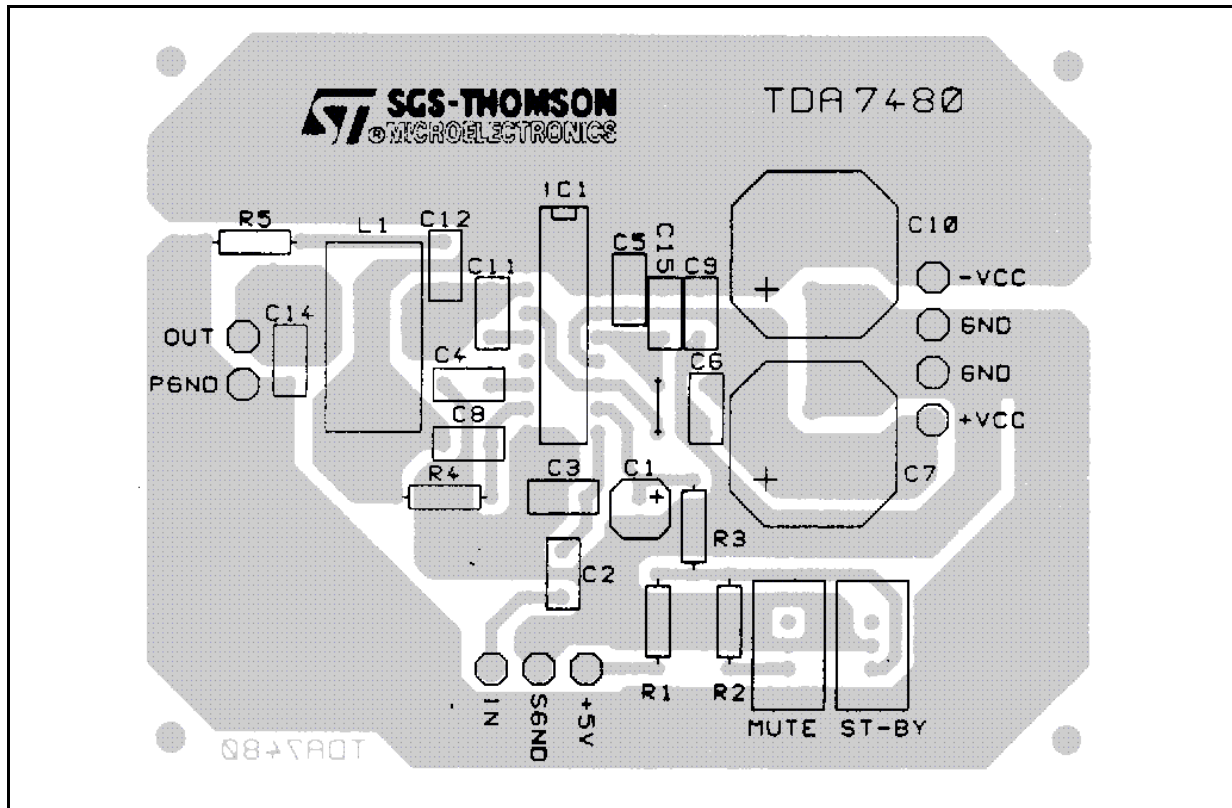
** P_O = measured across the load using the following inductor:
 COIL 58120 MPPA2 (magnetics) TURNS: 28 $\varnothing$ 1mm
 COIL77120 KOOL M μ (magnetics) TURNS: 28 $\varnothing$ 1mm

***: The zero-signal switching frequency can be obtained using the following expression: $F_{SW} = B_F/R_F$

****: The maximum value of R_F is related to the maximum possible value for the voltage drop on R_F itself.

(1): For $V_{12} > 5.2V$, an input impedance of $10K\Omega$ is to be considered.

Figure 2: Recommended P.C. Board and Component Layout of the Circuit of Figure1 (1.25:1 scale).



Note: Capacitor C5 must be as close as possible to device's pins 16 and 17

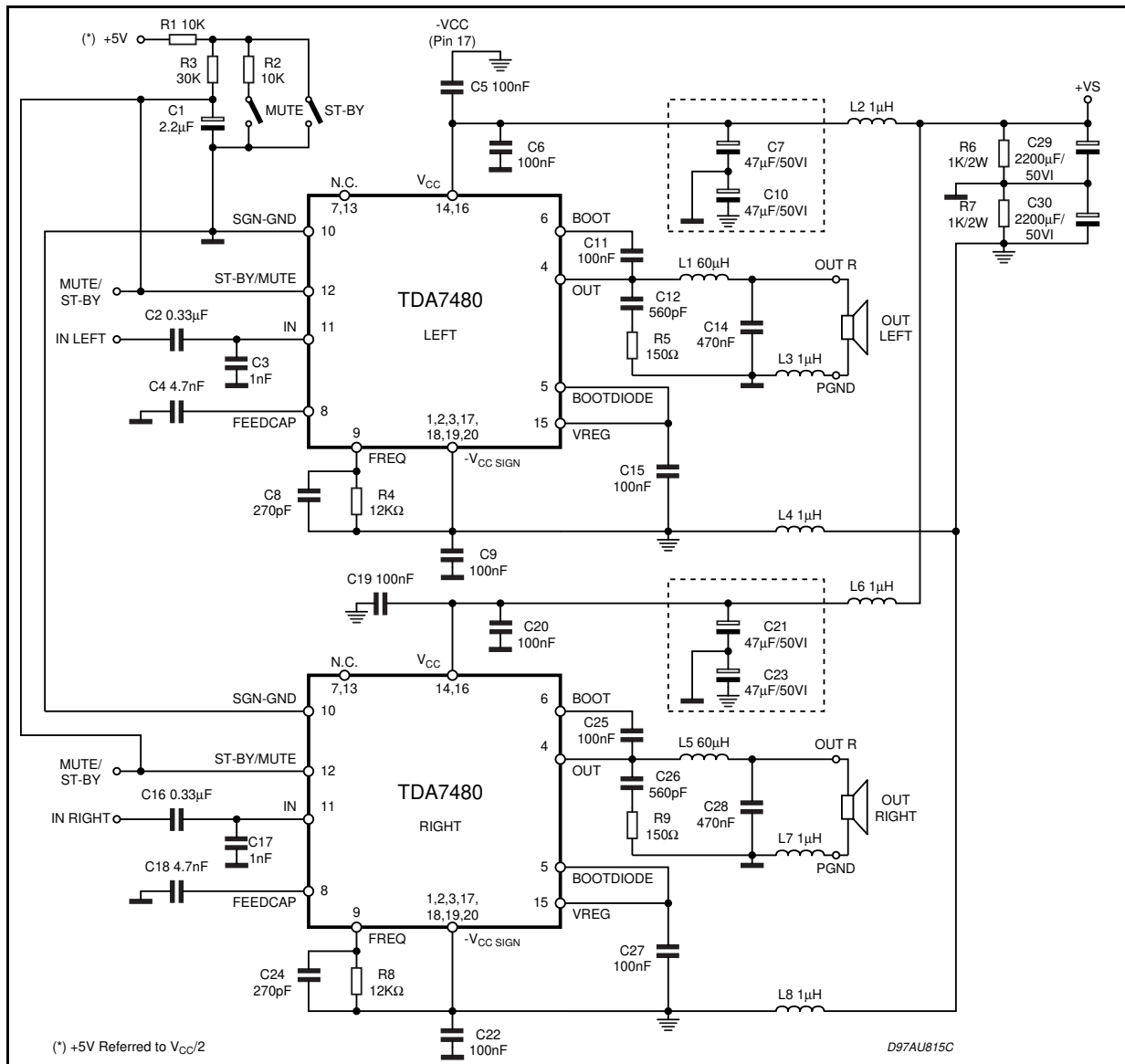
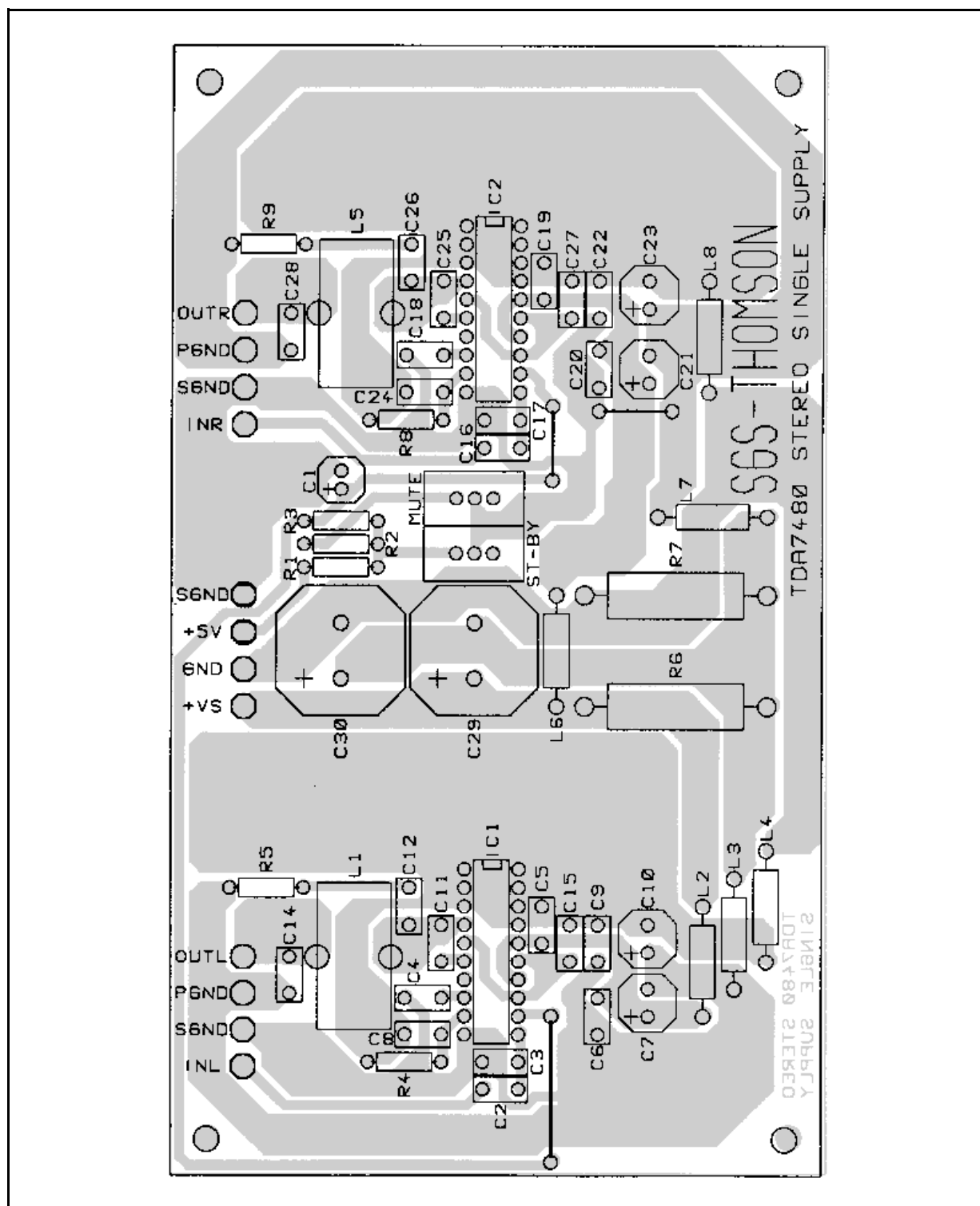
Figure 3: Stereo Application in Single Supply.

Figure 4: PC Board and component Layout of the Circuit of Figure 3.

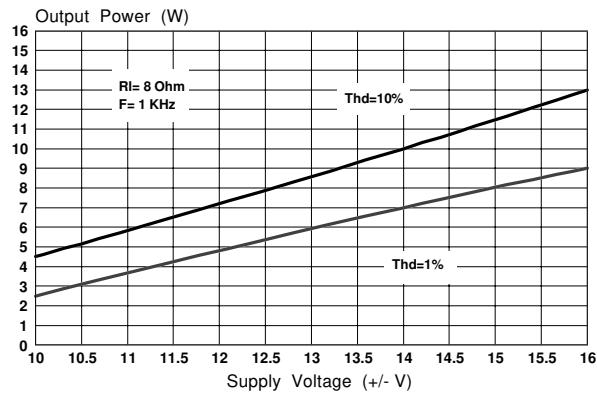
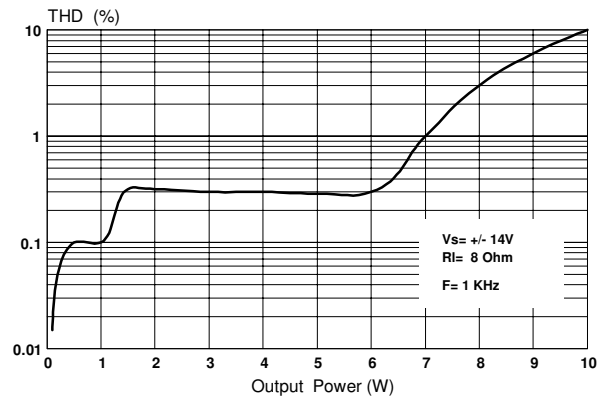
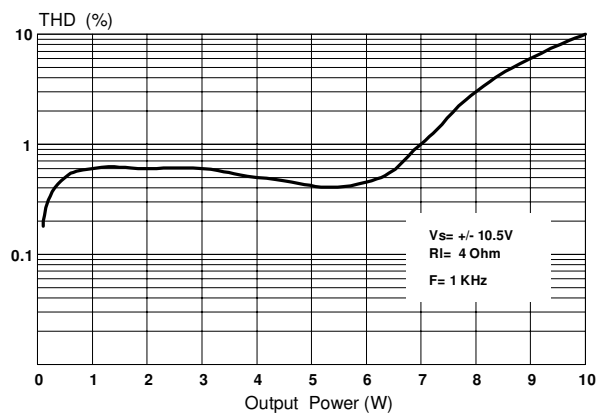
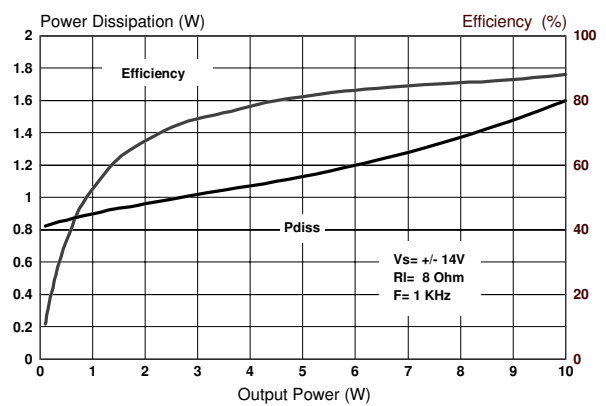
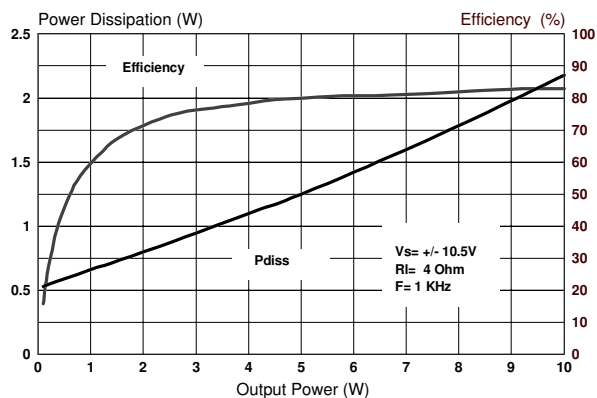
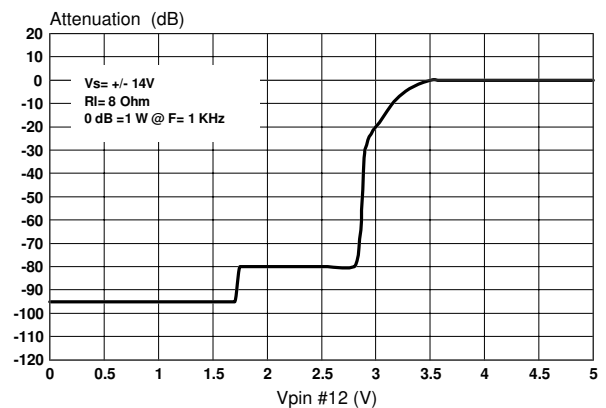
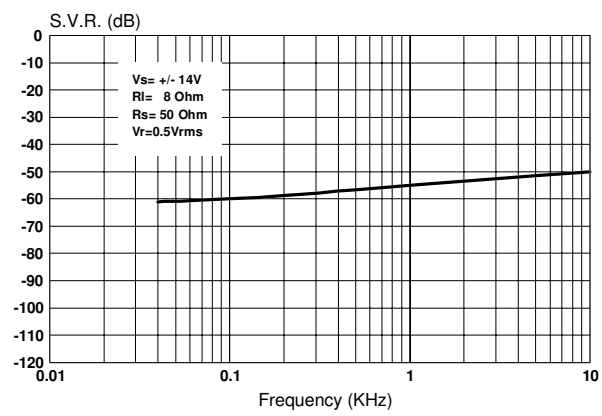
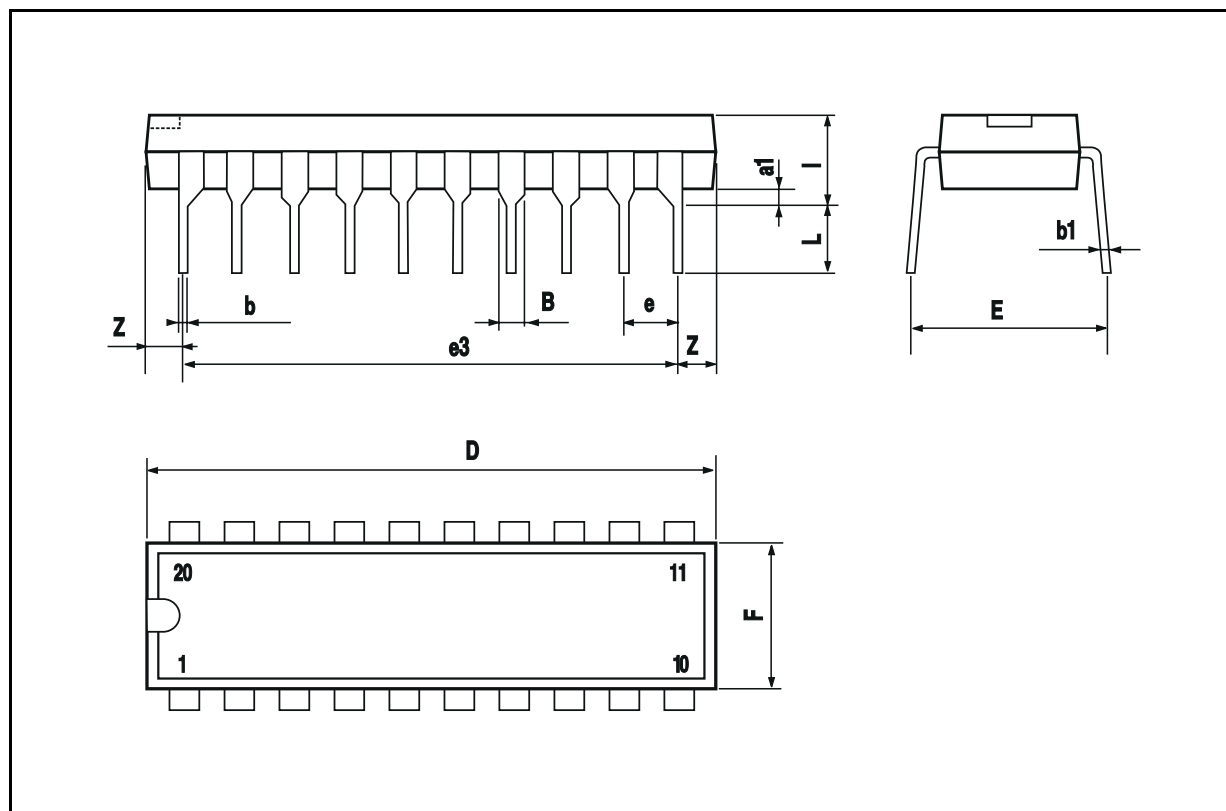
TYPICAL CHARACTERISTICS (Application Circuit of fig 1 unless otherwise specified)**Figure 5.** Output Power vs. Supply Voltage**Figure 6.** Distortion vs. Output Power**Figure 7.** Distortion vs. Output Power**Figure 8.** Power Dissipation and Efficiency vs. Output Power**Figure 9.** Power Dissipation and Efficiency vs. Output Power**Figure 10.** Mute Attenuation vs. Vpin 12

Figure 11. Supply Voltage Rejection vs. Frequency

POWERDIP20 PACKAGE MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.85		1.40	0.033		0.055
b		0.50			0.020	
b1	0.38		0.50	0.015		0.020
D			24.80			0.976
E		8.80			0.346	
e		2.54			0.100	
e3		22.86			0.900	
F			7.10			0.280
I			5.10			0.201
L		3.30			0.130	
Z			1.27			0.050



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